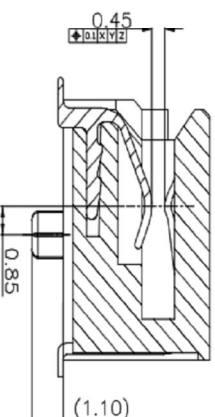
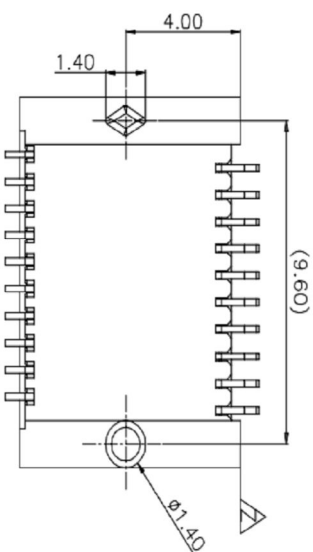
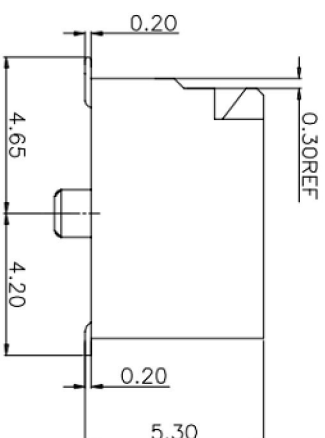
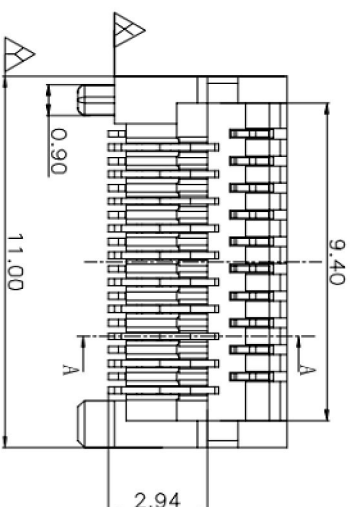


PC Board Layout
Component Side Shown



NOTE:
MECHANICAL:

CONNECTOR MATERIAL:

1. HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL 94V-0.
2. CONTACT: PHOSPHOR BRONZE THICKNESS=0.20mm.
3. PLATING: FULL GOLD PLATING OVER NICKEL 15u or 30u GOLD PLATING IN CONTACT AREA
4. DURABILITY: 100 CYCLES MIN.

ELECTRICAL:

1. VOLTAGE RATING : 30 VAC RMS MAX.
2. CURRENT RATING : 0.5 AMP MAX.
3. DIFFERENTIAL IMPEDANCE : 100 Ohms.
4. CAPACITANCE: 12pF MAX.
5. CONTACT RESISTANCE: 20 MILLIOHMS MAX.
6. INSULATION RESISTANCE: 500 MEGOHMS MIN.
7. DIELECTRIC WITHSTANDING: 300V AC/MIN.
8. TEMPERATURE: SOLDER TEMPERATURE SUGGEST 250°C~260°C.(5~10 sec)
OPERATING: -40°C to +85°C
STORAGE: -55°C to +105°C
ROHS COMPLIANT.

REV	ECN NO	DESCRIPTION	DATE
A	JIONS-SFP-0001		2010/01/12

JIONS 北京玖思启明电子科技有限公司

X	±0.30	APPR:	Mr. Wu	TITLE:
X	±0.20			sfp 半金锡 胶芯 20PIN
XX	±0.10	CHKD:	Mr. Wu	SMT
XXX	±0.05			
X	±2	DR:	Gus chong	PART NO: JIONS-0052
X	±1			
UNITS:	mm	SCALE:	1:1	DWG NO: 客户图
				WWW.JIONS.COM.CN
				SHEET: 10/1
				REV: